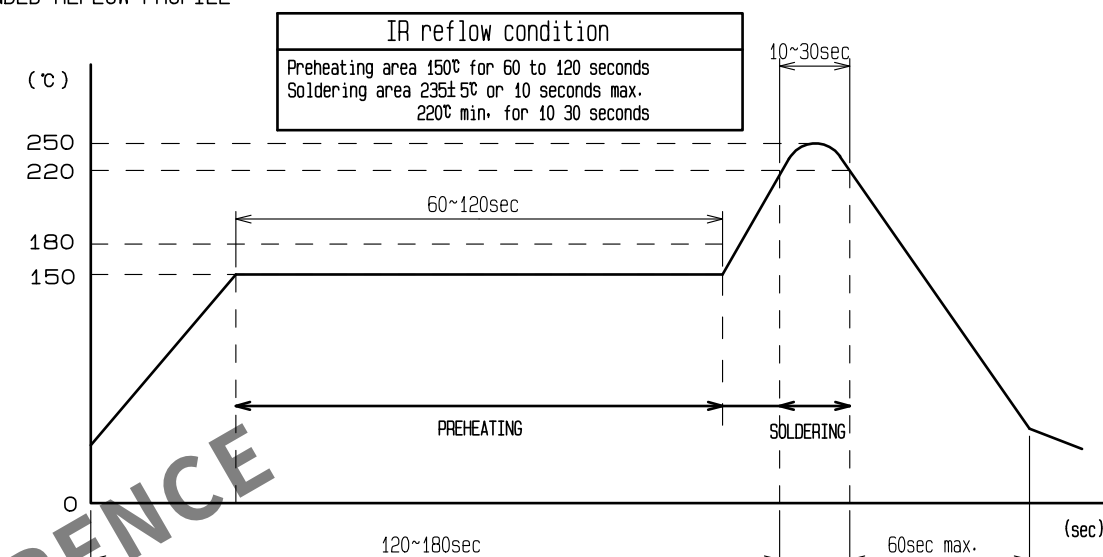
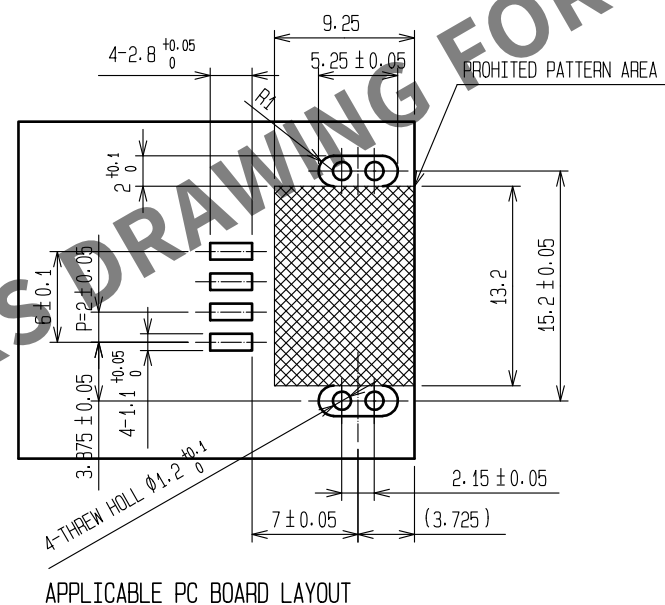
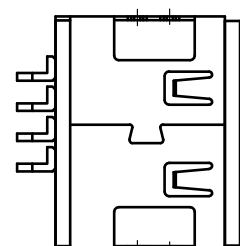
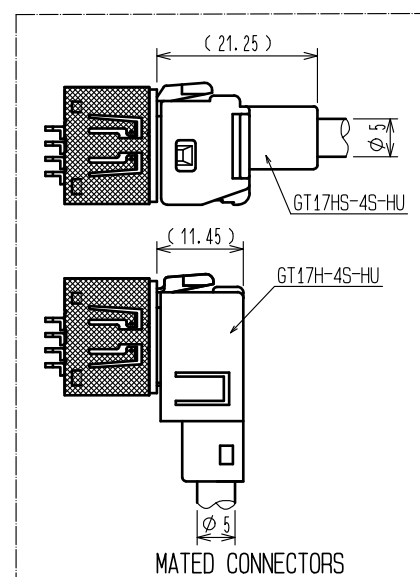
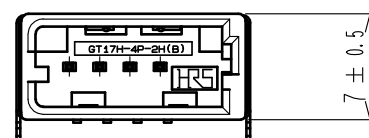
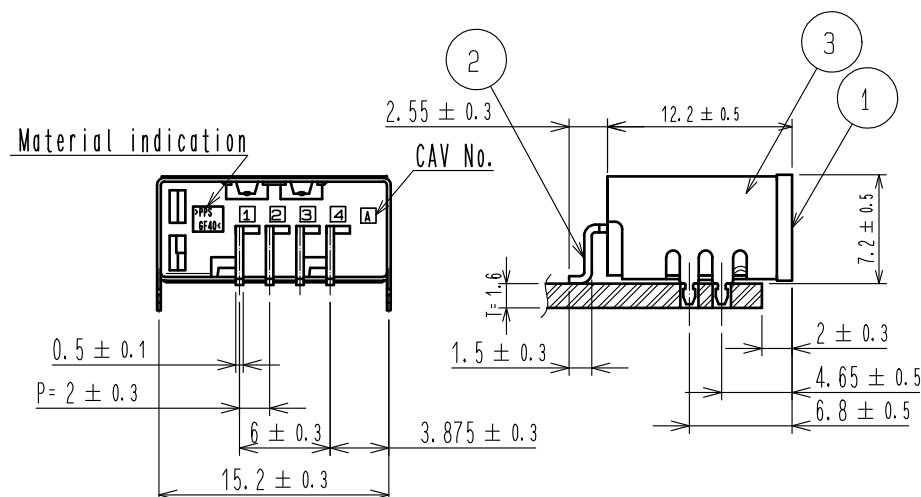
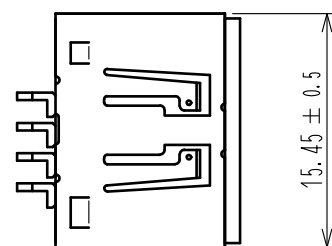
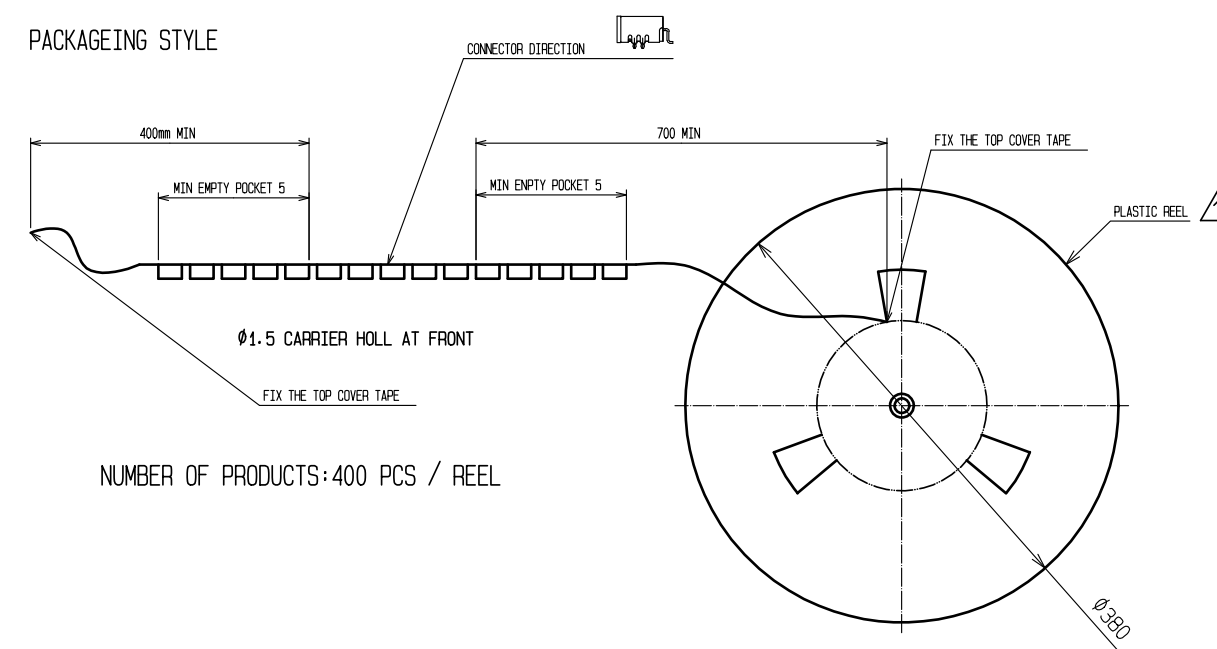




Note1. The soldering process is allowed up to twice under the same condition. However, the interval between the first and second process must be maintained at the room temperature.
Note2. The temperature indicates the board surface temperature on the connector lead area.



			
CL767-0083-3 GT17H-4P-2H COLOR : LIGHT GRAY	CL767-0170-6 GT17H-4P-2H(A) COLOR : BROWN	CL767-0171-9 GT17H-4P-2H(B) COLOR : GREEN	CL767-0172-1 GT17H-4P-2H(C) COLOR : BLUE
MATING INSULATOR : CL767-0084-6 GT17H-4S-2C COLOR : LIGHT GRAY	MATING INSULATOR : CL767-0167-1 GT17H-4S-2C(A) COLOR : BROWN	MATING INSULATOR : CL767-0168-4 GT17H-4S-2C(B) COLOR : GREEN	MATING INSULATOR : CL767-0169-7 GT17H-4S-2C(C) COLOR : BLUE

2	BRASS	Ni 1μm + Sn PLATING 2μm		4		
1	PPS	GREEN		3	COPPER ALLOY	Sn PLATING 1μm
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS

UNITS mm		SCALE		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
		2 : 1		1	DIS-T-00006678	TS. KUBOTA	EJ. WAKATSUKI	20200901

	HIROSE ELECTRIC CO., LTD.	APPROVED	: KI. HIROKAWA	20200326	DRAWING NO.	EDC-166943-55-00
		CHECKED	: EJ. WAKATSUKI	20200325		
		DESIGNED	: TS. KUBOTA	20200325	CODE NO.	CL767-0171-9-55
		DRAWN	: YK. MITSUISHI	20200219		